# 世界運算放大器 IC 特性手册

OP. AMP. IC DATA
AND
COMPARISION TABLES

電子學社出版

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# 内部交流

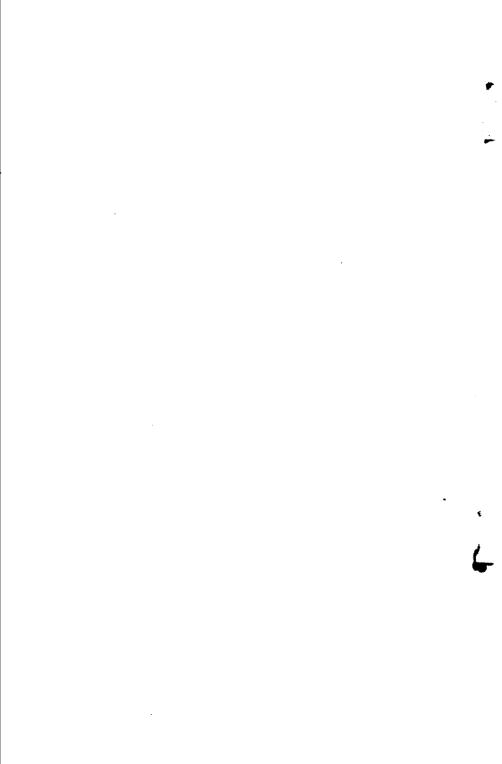
G 15/12世界运算放大器IC特性手册 (英3——5/40)

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# Contents

	Page	
Notes on use	5	
Abbreviations	9	Section
OPs and KOPs-Common relationship	13	1
Data and comparison tables	25	2
Pin assignments	153	3
Case outline drawings	225	4
Groups	237	5

# NOTES ON USE



#### NOTES ON USE

#### Location of a comparison type:

The basic type is to be found in section 2, which is arranged in alphanumerical sequence. The required comparison type is located in the appropriate column or, as indicated in the column, in the corresponding group in section 5. If no comparison type can be found in the same line in this group another type with a different free-air temperature range or a different casing can be selected according to its desired application.

#### Selecting an OP or KOP according to pin assignment:

As manufacturers have exhausted practically all pin assignment options it has not been possible to spare users the trouble of glancing through section 3 (pin assignments). This section contains brief descriptions and the appropriate types, to which the user may refer in section 2 (arranged alphabetically) in order to select a type with the suitable specification for the problem in hand.

# Selecting an OP or KOP according to the characteristics:

In this case also it is advisable to narrow down the choice of OPs by referring to the brief descriptions in section 3 (Breitband-OP for high unity gain, LP-OP for low-power, OTA for gain-adjust, etc.). Further details on those types which can be taken in consideration can be checked in section 2, which is arranged alphabetically.

# 使用说明

# 1. 怎样查找代换型号

在本书第二部分性能数据及代换型号表里,所有基本型号按字母数字顺序排列。在该表的代换型号一栏中,或者直接给出代换型号,或者指出应到第五部分那一个组别去找。在第五部分各型号按性能分成组列表,在表中同一横行中所列出的各型号均可互相替换。如果同一行中没有其他型号,就只好根据性能和使用条件另选一种使用温度范围或封装管出脚不同的型号了。

# 2. 按照管出脚排列选择运算放大器或比较器

由于同一种管脚排列有多种用途不同的型号,因此查找时必须将 第三部分(管出脚排列)全部查过。在本部分里给出用途简述及相应 的型号,可参照本书第二部分找出合适的一种。

# 3. 按照性能选择运算放大器或比较器

先根据第三部分的用途简述初步选出一些型号,再从第二部分查 出其详细特性以决定最合适的一种。

# **ABBREVIATIONS**

# **ABBREVIATIONS OF MANUFACTURERS**

#### **ABBREVIATIONS**

B. . . case outline drawing nr. . . .

Boos booster output

ch chip

CMRR common mode rejection ratio DCI pin for clamping diode

F non-inverting input Ē inverting input

F÷ symmetrical input, positive Е symmetrical input, negative

EKF input for frequency compensation

Ev input for gain-adjust fρ full power bandwidth unity gain bandwidth fт **FET** field effect transistor forward conductance a

GND around

HIREL high reliability  $h-\Omega$ high-impedance IABC gain-adjust current IFR input bias current leo input offset current lo output current

lR input for bias current adjustment

IC integrated circuit

KF frequency compensation KFE input frequency compensation KFO output frequency compensation

KOP comparator I P low-power  $n-\Omega$ low-impedance NC no internal connection OP operational amplifier

os overshoot OTA transconductance operational amplii er

P... pin assignment drawing nr....

PD bias power case ation total power dissipation

Po output power

PSRR positive supply voltage rejection ratio

Q asymmetrical output

 $egin{array}{ll} {\bf Q}_+ & & {
m symmetrical\ output,\ positive} \ {f Q}_- & & {
m symmetrical\ output,\ negative} \ \end{array}$ 

QKF output for frequency compensation

RE intput resistance
RL load resistance
RQ output resistance

SR slew-rate

Stabi voltage-regulator
strobe release input
tE recovery time
tK short circuit time

Tu free air temperature range
UDE differential input voltage
UDS differential supply voltage

UE input voltage
UE0 input offset voltage

Us supply voltage

Us+ positive supply voltage negative supply voltage

UQ output voltage

VI differential current amplification

VU full power response
ZA internal connection
ZE input impedance
ZQ output impedance

αE average temperature-coefficient of offset voltage average temperature-coefficient of offset current

0-SpA balance

#### **ABBREVIATIONS OF MANUFACTURERS**

AEG AEG / Telefunken

AMD Advanced Mikro Devices

AND Analog Devices

FCH Fairchild

HFO Halbleiterwerk Frankfurt / Oder

1SI Intersil

MIC Microsystems
MOT Motorola

NSC National Semiconductors Corporation

RAY Raytheon RCA

RIZ Riz / Jugosławien

SES Sescosem
SGS Ates / SGS
SIE Siemens
SIG Signetics

SIL Silicon General

SOL Solitron
SPR Sprague
TDY Teledyne

TES Tesla / UdSSR
TIX Texas Instruments

TRA Transitron VAL Valvo

# **SECTION 1**

**OPS AND KOPS - COMMON RELATIONSHIPS** 

一般关系(运算放大器和比较器)

1

#### **OPS AND KOPS - COMMON RELATIONSHIPS**

#### 1. Dependence of the output on the differential input voltage:

#### a) OPs

After the pading  $U_Q$  remains in the saturation range until  $U_{DE}$  falls to a YUQX mum of 0,12 mV and then returns to within the nominal voltage range after the recovery time  $t_E$  has elapsed.

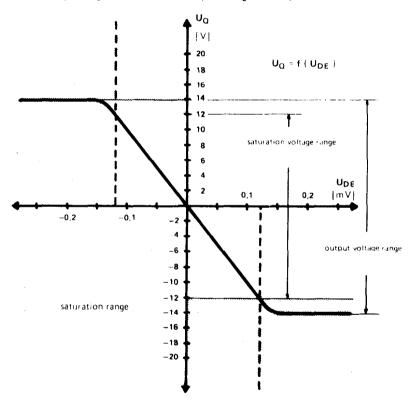


Fig. 1a: Relationship between input / output voltage for OP (inverting) at 100 dB voltage gain.

#### b) KOPs

In the case of the KOP the output voltage reacts quicker to changes in the input voltage. It is not — as in the case of the OP — proportional to the input voltage but tilts when an externally adjustable threshold value is reached. By means of an external connection with a clamping diode (at terminal  $D_{CL}$ ) the output voltage is prevented from entering the saturation range which eliminates recovery time  $t_E$ .

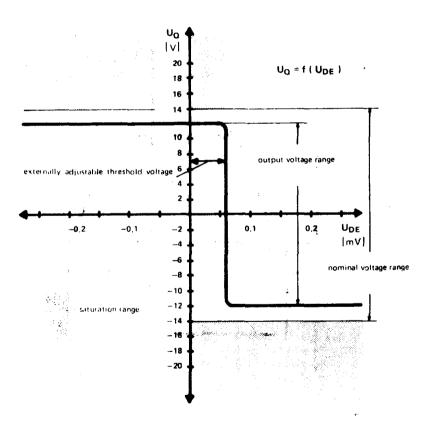


Fig. 1b: Relationship between input / output voltage for KOP with external connection via clamping diode.

# 2. Dependence of output voltage on time:

$$SR \approx U_{Omax} \cdot 2\pi f_P$$

The slew-rate indicates the rise speed of the output signal when the differential input signal changes in rectangular form. If not given, it is calculated from the above relationship.

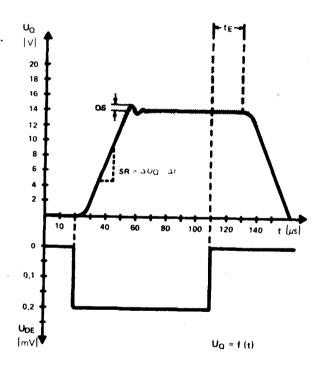


Fig. 2: Output voltage as a function of time (full output voltage at unity gain, OS = 10% and SR = 0.5  $V/\mu s$ )